



Product Change Notification

Change Notification #: 115580 - 00
Change Title: Intel® Joule™ 570x Compute Module,
Intel® Joule™ 550x Compute Module,
Intel® Joule™ 570x Developer Kit and,
Intel® Joule™ 550x Developer Kit Products,
PCN 115580-00,
Product Discontinuance, End of Life
Date of Publication: June 16, 2017

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Product Discontinuance Program Support Begins:	June 16, 2017
Product Discontinuance Demand To Local Intel Representative:	July 16, 2017
Last Product Discontinuance Order Date:	September 16, 2017
Orders are Non-Cancelable and Non-Returnable After:	September 16, 2017
Last Product Discontinuance Shipment Date:	December 16, 2017

Description of Change to the Customer:

Intel Corporation will discontinue manufacturing and selling all skus of the Intel® Joule™ Compute Modules and Developer Kits (known as Intel® 500 Series compute modules in People's Republic of China).

Shipment of all Intel® Joule™ products skus ordered before the last order date will continue to be available from Intel until December 16, 2017. Last time orders (LTO) for any Intel® Joule™ products must be placed with Intel by September 16, 2017.

All orders placed with Intel for Intel® Joule™ products are non-cancelable and non-returnable after September 16, 2017.

Customer Impact of Change and Recommended Action:

The products listed on the "Products Affected/Intel Ordering Codes" table should be managed in accordance to the "Key Milestones" listed above. Supply is limited and will be committed out to orders as a "first come, first serve" basis until supply is depleted.

Please contact your local Intel Field Sales representative if you have any further questions about this End of Life notice.

Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#
Intel® Joule™ 570x Developer Kit with Expansion Board, Single	GT.PDKW	951308
Intel® 570x Compute Module, 30-pack	GT.PMPW	951311
Intel® 550x Compute Module, 30-pack	GT.EMPW	951312
Intel® Joule™ 550x Developer Kit with Expansion Board, Single	GT.EDKW	951506
Intel® Joule™ 570x Compute Module, Single	GT.PW	951672
Intel® Joule™ 550x Compute Module, Single	GT.EW	951673
Intel® Joule™ 570x Developer Kit with Expansion Board, Single	GT2.PDKW	955418
Intel® Joule™ 570x Compute Module, Single	GT2.PW	955419
Intel® 570x Compute Module, 30-pack	GT2.PMPW	955422
Intel® 550x Compute Module, 30-pack	GT2.EMPW	955426
Intel® Joule™ 550x compute module, Single (2 antennas)	GT2.EW	955425
Intel® Joule™ 550x developer kit with expansion board, Single	GT2.EDKW	955424

PCN Revision History:

Date of Revision:

June 16, 2017

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

115580 - 00

INFORMATION IN THIS DOCUMENT IS PROVIDED IN CONNECTION WITH INTEL PRODUCTS. NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT. EXCEPT AS PROVIDED IN INTEL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, INTEL ASSUMES NO LIABILITY WHATSOEVER AND INTEL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY, RELATING TO SALE AND/OR USE OF INTEL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

A "Mission Critical Application" is any application in which failure of the Intel Product could result, directly or indirectly, in personal injury or death. SHOULD YOU PURCHASE OR USE INTEL'S PRODUCTS FOR ANY SUCH MISSION CRITICAL APPLICATION, YOU SHALL INDEMNIFY AND HOLD INTEL AND ITS SUBSIDIARIES, SUBCONTRACTORS AND AFFILIATES, AND THE DIRECTORS, OFFICERS, AND EMPLOYEES OF EACH, HARMLESS AGAINST ALL CLAIMS COSTS, DAMAGES, AND EXPENSES AND REASONABLE ATTORNEYS' FEES ARISING OUT OF, DIRECTLY OR INDIRECTLY, ANY CLAIM OF PRODUCT LIABILITY, PERSONAL INJURY, OR DEATH ARISING IN ANY WAY OUT OF SUCH MISSION CRITICAL APPLICATION, WHETHER OR NOT INTEL OR ITS SUBCONTRACTOR WAS NEGLIGENT IN THE DESIGN, MANUFACTURE, OR WARNING OF THE INTEL PRODUCT OR ANY OF ITS PARTS.

Intel may make changes to specifications and product descriptions at any time, without notice. Designers must not rely on the absence or characteristics of any features or instructions marked "reserved" or "undefined". Intel reserves these for future definition and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them. The information here is subject to change without notice. Do not finalize a design with this information.

The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

Copyright © Intel Corporation 2017. Other names and brands may be claimed as the property of others.

3D XPoint, Axxia, Basis, Basis Peak, BlueMoon, BunnyPeople, Celeron, Centrino, Cilk, Curie, Flexpipe, Intel, the Intel logo, Intel Atom, Intel CoFluent, Intel Core, Intel. Experience What's Inside, the Intel. Experience What's Inside logo, Intel Inside, the Intel Inside logo, Intel Insider, Intel Joule, Intel RealSense, Intel SingleDriver, Intel SpeedStep, Intel Unite, Intel vPro, Intel Xeon Phi, Intel XScale, InTru, the InTru logo, the InTru Inside logo, InTru soundmark, Iris, Itanium, MCS, MMX, Optane, Ostro, Pali, Pentium, picoArray, Picochip, picoXcell, Puma, Quark, SMARTi, Soletta, Sound Mark, StarPro, Stay With It, the Engineering Stay With It logo, StreamSight, Tarari, The Journey Inside, Thunderbolt, the Thunderbolt logo, Transcende, True Key, Ultrabook, VTune, Xeon, X-GOLD, XMM, X-PMU and XPOSYS are trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries.

Microsoft, Windows, and the Windows logo are trademarks, or registered trademarks of Microsoft Corporation in the United States and/or other countries. Java is a registered trademark of Oracle and/or its affiliates. Bluetooth is a trademark owned by its proprietor and used by Intel Corporation under license. Intel Corporation uses the Palm OS* Ready mark under license from Palm, Inc. OpenCL and the OpenCL logo are trademarks of Apple Inc. used by permission by Khronos. Learn how to use Intel Trademarks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.